Features

- High-performance, Low-power Atmel® AVR® 8-bit Microcontroller
- Advanced RISC Architecture
  - 131 Powerful Instructions – Most Single-clock Cycle Execution
  - 32 × 8 General Purpose Working Registers
  - Fully Static Operation
  - Up to 16 MIPS Throughput at 16 MHz
  - On-chip 2-cycle Multiplier
- High Endurance Non-volatile Memory segments
  - 16 Kbytes of In-System Self-programmable Flash program memory
  - 512 Bytes EEPROM
  - 1 Kbyte Internal SRAM
  - Write/Erase Cycles: 10,000 Flash/100,000 EEPROM
  - Data retention: 20 years at 85°C/100 years at 25°C(1)
  - Optional Boot Code Section with Independent Lock Bits
    In-System Programming by On-chip Boot Program
    True Read-While-Write Operation
  - Programming Lock for Software Security
- JTAG (IEEE std. 1149.1 Compliant) Interface
  - Boundary-scan Capabilities According to the JTAG Standard
  - Extensive On-chip Debug Support
  - Programming of Flash, EEPROM, Fuses, and Lock Bits through the JTAG Interface
- Peripheral Features
  - Two 8-bit Timer/Counters with Separate Prescalers and Compare Modes
  - One 16-bit Timer/Counter with Separate Prescaler, Compare Mode, and Capture Mode
  - Real Time Counter with Separate Oscillator
  - Four PWM Channels
  - 8-channel, 10-bit ADC
    8 Single-ended Channels
    7 Differential Channels in TQFP Package Only
    2 Differential Channels with Programmable Gain at 1x, 10x, or 200x
  - Byte-oriented Two-wire Serial Interface
  - Programmable Serial USART
  - Master/Slave SPI Serial Interface
  - Programmable Watchdog Timer with Separate On-chip Oscillator
  - On-chip Analog Comparator
- Special Microcontroller Features
  - Power-on Reset and Programmable Brown-out Detection
  - Internal Calibrated RC Oscillator
  - External and Internal Interrupt Sources
  - Six Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, Standby and Extended Standby
- I/O and Packages
  - 32 Programmable I/O Lines
  - 40-pin PDIP, 44-lead TQFP, and 44-pad QFN/MLF
- Operating Voltages
  - 2.7V - 5.5V for ATmega16L
  - 4.5V - 5.5V for ATmega16
- Speed Grades
  - 0 - 8 MHz for ATmega16L
  - 0 - 16 MHz for ATmega16
- Power Consumption @ 1 MHz, 3V, and 25°C for ATmega16L
  - Active: 1.1 mA
  - Idle Mode: 0.35 mA
  - Power-down Mode: < 1 µA

8-bit AVR® Microcontroller with 16K Bytes In-System Programmable Flash

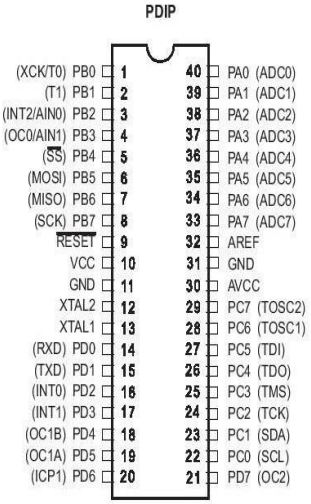
ATmega16
ATmega16L

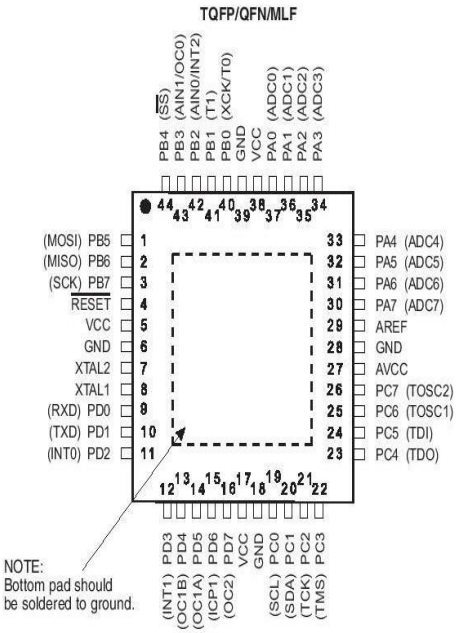
Summary

Rev. 2466TS–AVR–07/10

Pin Configurations

Figure 1. Pinout ATmega16





Disclaimer

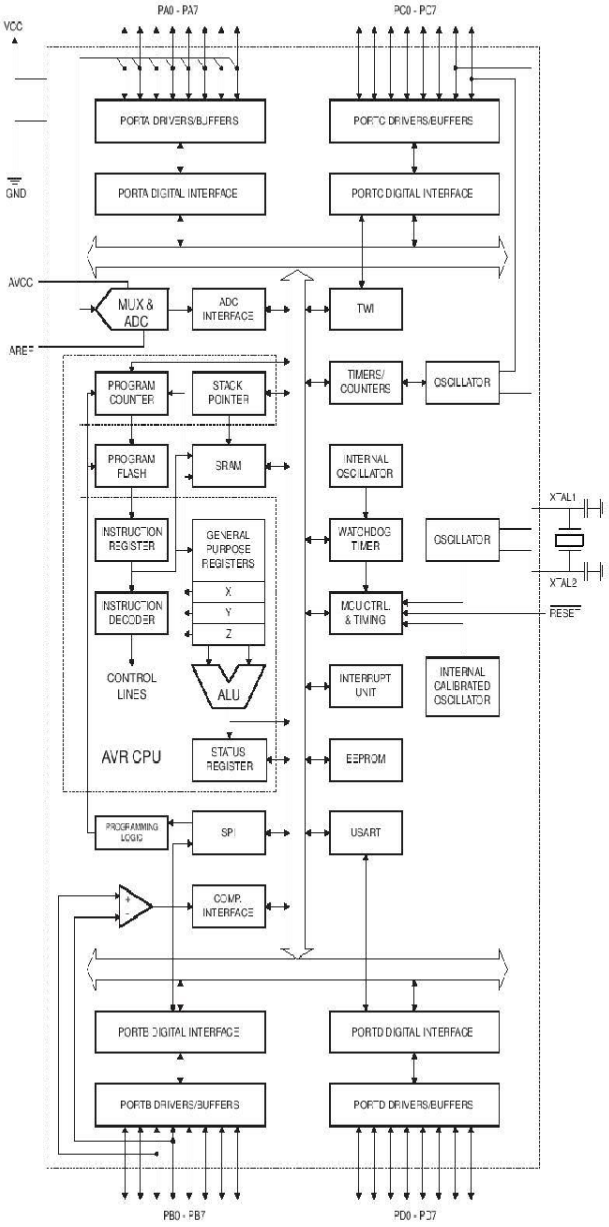
Typical values contained in this datasheet are based on simulations and characterization of other AVR microcontrollers manufactured on the same process technology. Min and Max values will be available after the device is characterized.

Overview

The ATmega16 is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega16 achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

Block Diagram

Figure 2. Block Diagram



The AVR core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATmega16 provides the following features: 16 Kbytes of In-System Programmable Flash Program memory with Read-While-Write capabilities, 512 bytes EEPROM, 1 Kbyte SRAM, 32 general purpose I/O lines, 32 general purpose working registers, a JTAG interface for Boundary-scan, On-chip Debugging support and programming, three flexible Timer/Counters with compare modes, Internal and External Interrupts, a serial programmable USART, a byte oriented Two-wire Serial Interface, an 8-channel, 10-bit ADC with optional differential input stage with programmable gain (TQFP package only), a programmable Watchdog Timer with Internal Oscillator, an SPI serial port, and six software selectable power saving modes. The Idle mode stops the CPU while allowing the USART, Two-wire interface, A/D Converter, SRAM, Timer/Counters, SPI port, and interrupt system to continue functioning. The Power-down mode saves the register contents but freezes the Oscillator, disabling all other chip functions until the next External Interrupt or Hardware Reset. In Power-save mode, the Asynchronous Timer continues to run, allowing the user to maintain a timer base while the rest of the device is sleeping. The ADC Noise Reduction mode stops the CPU and all I/O modules except Asynchronous Timer and ADC, to minimize switching noise during ADC conversions. In Standby mode, the crystal/resonator Oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low-power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run.

The device is manufactured using Atmel's high density nonvolatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed in-system through an SPI serial interface, by a conventional nonvolatile memory programmer, or by an On-chip Boot program running on the AVR core. The boot program can use any interface to download the application program in the Application Flash memory. Software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATmega16 is a powerful microcontroller that provides a highly-flexible and cost-effective solution to many embedded control applications.

The ATmega16 AVR is supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, in-circuit emulators, and evaluation kits.

Pin Descriptions

VCC Digital supply voltage.

GND Ground.

Port A (PA7..PA0) Port A serves as the analog inputs to the A/D Converter.

Port A also serves as an 8-bit bi-directional I/O port, if the A/D Converter is not used. Port pins can provide internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source capability. When pins PA0 to PA7 are used as inputs and are externally pulled low, they will source current if the internal pull-up resistors are activated. The Port A pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B (PB7..PB0) Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B also serves the functions of various special features of the ATmega16 as listed on page 58.

Port C (PC7..PC0) Port C is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port C output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tri-stated when a reset condition becomes active, even if the clock is not running. If the JTAG interface is enabled, the pull-up resistors on pins PC5(TDI), PC3(TMS) and PC2(TCK) will be activated even if a reset occurs.

Port C also serves the functions of the JTAG interface and other special features of the ATmega16 as listed on page 61.

Port D (PD7..PD0) Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port D also serves the functions of various special features of the ATmega16 as listed on page 63.

$\overline{\text{RESET}}$ Reset Input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. The minimum pulse length is given in Table 15 on page 38. Shorter pulses are not guaranteed to generate a reset.

XTAL1 Input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

XTAL2 Output from the inverting Oscillator amplifier.

AVCC AVCC is the supply voltage pin for Port A and the A/D Converter. It should be externally connected to V_{CC}, even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} through a low-pass filter.

AREF AREF is the analog reference pin for the A/D Converter.

Resources

A comprehensive set of development tools, application notes and datasheets are available for download on http://www.atmel.com/avr.

Data Retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C or 100 years at 25°C.

Register Summary

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
$3F ($5F)	SREG	I	T	H	S	V	N	Z	C	9
$3E ($5E)	SPH	–	–	–	–	–	SP10	SP9	SP8	12
$3D ($5D)	SPL	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	12
$3C ($5C)	OCR0	Timer/Counter0 Output Compare Register								85
$3B ($5B)	GICR	INT1	INT0	INT2	–	–	–	IVSEL	IVCE	46, 69
$3A ($5A)	GIFR	INTF1	INTF0	INTF2	–	–	–	–	–	70
$39 ($59)	TIMSK	OCIE2	TOIE2	TICIE1	OCIE1A	OCIE1B	TOIE1	OCIE0	TOIE0	85, 115, 133
$38 ($58)	TIFR	OCF2	TOV2	ICF1	OCF1A	OCF1B	TOV1	OCF0	TOV0	86, 115, 133
$37 ($57)	SPMCR	SPMIE	RWWSB	–	RWWSRE	BLBSET	PGWRT	PGERS	SPMEN	250
$36 ($56)	TWCR	TWINT	TWEA	TWSTA	TWSTO	TWWC	TWEN	–	TWIE	180
$35 ($55)	MCUCR	SM2	SE	SM1	SM0	ISC11	ISC10	ISC01	ISC00	32, 68
$34 ($54)	MCUCSR	JTD	ISC2	–	JTRF	WDRF	BORF	EXTRF	PORF	41, 69, 231
$33 ($53)	TCCR0	FOC0	WGM00	COM01	COM00	WGM01	CS02	CS01	CS00	83
$32 ($52)	TCNT0	Timer/Counter0 (8 Bits)								85
$31[1] ($51)[1]	OSCCAL	Oscillator Calibration Register								30
	OCDR	On-Chip Debug Register								227
$30 ($50)	SFIOR	ADTS2	ADTS1	ADTS0	–	ACME	PUD	PSR2	PSR10	57,88,134,201,221
$2F ($4F)	TCCR1A	COM1A1	COM1A0	COM1B1	COM1B0	FOC1A	FOC1B	WGM11	WGM10	110
$2E ($4E)	TCCR1B	ICNC1	ICES1	–	WGM13	WGM12	CS12	CS11	CS10	113
$2D ($4D)	TCNT1H	Timer/Counter1 – Counter Register High Byte								114
$2C ($4C)	TCNT1L	Timer/Counter1 – Counter Register Low Byte								114
$2B ($4B)	OCR1AH	Timer/Counter1 – Output Compare Register A High Byte								114
$2A ($4A)	OCR1AL	Timer/Counter1 – Output Compare Register A Low Byte								114
$29 ($49)	OCR1BH	Timer/Counter1 – Output Compare Register B High Byte								114
$28 ($48)	OCR1BL	Timer/Counter1 – Output Compare Register B Low Byte								114
$27 ($47)	ICR1H	Timer/Counter1 – Input Capture Register High Byte								114
$26 ($46)	ICR1L	Timer/Counter1 – Input Capture Register Low Byte								114
$25 ($45)	TCCR2	FOC2	WGM20	COM21	COM20	WGM21	CS22	CS21	CS20	128
$24 ($44)	TCNT2	Timer/Counter2 (8 Bits)								130
$23 ($43)	OCR2	Timer/Counter2 Output Compare Register								130
$22 ($42)	ASSR	–	–	–	–	AS2	TCN2UB	OCR2UB	TCR2UB	131
$21 ($41)	WDTCR	–	–	–	WDTOE	WDE	WDP2	WDP1	WDP0	43
$20[2] ($40)[2]	UBRRH	URSEL	–	–	–	UBRR[11:8]				167
	UCSRC	URSEL	UMSEL	UPM1	UPM0	USBS	UCSZ1	UCSZ0	UCPOL	166
$1F ($3F)	EEARH	–	–	–	–	–	–	–	EEAR8	19
$1E ($3E)	EEARL	EEPROM Address Register Low Byte								19
$1D ($3D)	EEDR	EEPROM Data Register								19
$1C ($3C)	EECR	–	–	–	–	EERIE	EEMWE	EEWE	EERE	19
$1B ($3B)	PORTA	PORTA7	PORTA6	PORTA5	PORTA4	PORTA3	PORTA2	PORTA1	PORTA0	66
$1A ($3A)	DDRA	DDA7	DDA6	DDA5	DDA4	DDA3	DDA2	DDA1	DDA0	66
$19 ($39)	PINA	PINA7	PINA6	PINA5	PINA4	PINA3	PINA2	PINA1	PINA0	66
$18 ($38)	PORTB	PORTB7	PORTB6	PORTB5	PORTB4	PORTB3	PORTB2	PORTB1	PORTB0	66
$17 ($37)	DDRB	DDB7	DDB6	DDB5	DDB4	DDB3	DDB2	DDB1	DDB0	66
$16 ($36)	PINB	PINB7	PINB6	PINB5	PINB4	PINB3	PINB2	PINB1	PINB0	66
$15 ($35)	PORTC	PORTC7	PORTC6	PORTC5	PORTC4	PORTC3	PORTC2	PORTC1	PORTC0	67
$14 ($34)	DDRC	DDC7	DDC6	DDC5	DDC4	DDC3	DDC2	DDC1	DDC0	67
$13 ($33)	PINC	PINC7	PINC6	PINC5	PINC4	PINC3	PINC2	PINC1	PINC0	67
$12 ($32)	PORTD	PORTD7	PORTD6	PORTD5	PORTD4	PORTD3	PORTD2	PORTD1	PORTD0	67
$11 ($31)	DDRD	DDD7	DDD6	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0	67
$10 ($30)	PIND	PIND7	PIND6	PIND5	PIND4	PIND3	PIND2	PIND1	PIND0	67
$0F ($2F)	SPDR	SPI Data Register								142
$0E ($2E)	SPSR	SPIF	WCOL	–	–	–	–	–	SPI2X	142
$0D ($2D)	SPCR	SPIE	SPE	DORD	MSTR	CPOL	CPHA	SPR1	SPR0	140
$0C ($2C)	UDR	USART I/O Data Register								163
$0B ($2B)	UCSRA	RXC	TXC	UDRE	FE	DOR	PE	U2X	MPCM	164
$0A ($2A)	UCSRB	RXCIE	TXCIE	UDRIE	RXEN	TXEN	UCSZ2	RXB8	TXB8	165
$09 ($29)	UBRRL	USART Baud Rate Register Low Byte								167
$08 ($28)	ACSR	ACD	ACBG	ACO	ACI	ACIE	ACIC	ACIS1	ACIS0	202
$07 ($27)	ADMUX	REFS1	REFS0	ADLAR	MUX4	MUX3	MUX2	MUX1	MUX0	217
$06 ($26)	ADCSRA	ADEN	ADSC	ADATE	ADIF	ADIE	ADPS2	ADPS1	ADPS0	219
$05 ($25)	ADCH	ADC Data Register High Byte								220
$04 ($24)	ADCL	ADC Data Register Low Byte								220
$03 ($23)	TWDR	Two-wire Serial Interface Data Register								182
$02 ($22)	TWAR	TWA6	TWA5	TWA4	TWA3	TWA2	TWA1	TWA0	TWGCE	182

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
$01 ($21)	TWSR	TWS7	TWS6	TWS5	TWS4	TWS3	–	TWPS1	TWPS0	181
$00 ($20)	TWBR	Two-wire Serial Interface Bit Rate Register								180

Notes:
1. When the OCDEN Fuse is unprogrammed, the OSCCAL Register is always accessed on this address. Refer to the debugger specific documentation for details on how to use the OCDR Register.
2. Refer to the USART description for details on how to access UBRRH and UCSRC.
3. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.
4. Some of the Status Flags are cleared by writing a logical one to them. Note that the CBI and SBI instructions will operate on all bits in the I/O Register, writing a one back into any flag read as set, thus clearing the flag. The CBI and SBI instructions work with registers $00 to $1F only.

Instruction Set Summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
ARITHMETIC AND LOGIC INSTRUCTIONS					
ADD	Rd, Rr	Add two Registers	Rd ← Rd + Rr	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	Rd ← Rd + Rr + C	Z,C,N,V,H	1
ADIW	Rdl,K	Add Immediate to Word	Rdh:Rdl ← Rdh:Rdl + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	Rd ← Rd - Rr	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	Rd ← Rd - K	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	Rd ← Rd - Rr - C	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	Rd ← Rd - K - C	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	Rdh:Rdl ← Rdh:Rdl - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	Rd ← Rd • Rr	Z,N,V	1
ANDI	Rd, K	Logical AND Register and Constant	Rd ← Rd • K	Z,N,V	1
OR	Rd, Rr	Logical OR Registers	Rd ← Rd v Rr	Z,N,V	1
ORI	Rd, K	Logical OR Register and Constant	Rd ← Rd v K	Z,N,V	1
EOR	Rd, Rr	Exclusive OR Registers	Rd ← Rd ⊕ Rr	Z,N,V	1
COM	Rd	One's Complement	Rd ← $FF - Rd	Z,C,N,V	1
NEG	Rd	Two's Complement	Rd ← $00 - Rd	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	Rd ← Rd v K	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	Rd ← Rd • ($FF - K)	Z,N,V	1
INC	Rd	Increment	Rd ← Rd + 1	Z,N,V	1
DEC	Rd	Decrement	Rd ← Rd – 1	Z,N,V	1
TST	Rd	Test for Zero or Minus	Rd ← Rd • Rd	Z,N,V	1
CLR	Rd	Clear Register	Rd ← Rd ⊕ Rd	Z,N,V	1
SER	Rd	Set Register	Rd ← $FF	None	1
MUL	Rd, Rr	Multiply Unsigned	R1:R0 ← Rd x Rr	Z,C	2
MULS	Rd, Rr	Multiply Signed	R1:R0 ← Rd x Rr	Z,C	2
MULSU	Rd, Rr	Multiply Signed with Unsigned	R1:R0 ← Rd x Rr	Z,C	2
FMUL	Rd, Rr	Fractional Multiply Unsigned	R1:R0 ← (Rd x Rr) << 1	Z,C	2
FMULS	Rd, Rr	Fractional Multiply Signed	R1:R0 ← (Rd x Rr) << 1	Z,C	2
FMULSU	Rd, Rr	Fractional Multiply Signed with Unsigned	R1:R0 ← (Rd x Rr) << 1	Z,C	2
BRANCH INSTRUCTIONS					
RJMP	k	Relative Jump	PC ← PC + k + 1	None	2
IJMP		Indirect Jump to (Z)	PC ← Z	None	2
JMP	k	Direct Jump	PC ← k	None	3
RCALL	k	Relative Subroutine Call	PC ← PC + k + 1	None	3
ICALL		Indirect Call to (Z)	PC ← Z	None	3
CALL	k	Direct Subroutine Call	PC ← k	None	4
RET		Subroutine Return	PC ← STACK	None	4
RETI		Interrupt Return	PC ← STACK	I	4
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC ← PC + 2 or 3	None	1 / 2 / 3
CP	Rd,Rr	Compare	Rd – Rr	Z, N,V,C,H	1
CPC	Rd,Rr	Compare with Carry	Rd – Rr – C	Z, N,V,C,H	1
CPI	Rd,K	Compare Register with Immediate	Rd – K	Z, N,V,C,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b)=0) PC ← PC + 2 or 3	None	1 / 2 / 3
SBRS	Rr, b	Skip if Bit in Register is Set	if (Rr(b)=1) PC ← PC + 2 or 3	None	1 / 2 / 3
SBIC	P, b	Skip if Bit in I/O Register Cleared	if (P(b)=0) PC ← PC + 2 or 3	None	1 / 2 / 3
SBIS	P, b	Skip if Bit in I/O Register is Set	if (P(b)=1) PC ← PC + 2 or 3	None	1 / 2 / 3
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC←PC+k + 1	None	1 / 2
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 0) then PC←PC+k + 1	None	1 / 2
BREQ	k	Branch if Equal	if (Z = 1) then PC ← PC + k + 1	None	1 / 2
BRNE	k	Branch if Not Equal	if (Z = 0) then PC ← PC + k + 1	None	1 / 2
BRCS	k	Branch if Carry Set	if (C = 1) then PC ← PC + k + 1	None	1 / 2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC ← PC + k + 1	None	1 / 2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC ← PC + k + 1	None	1 / 2
BRLO	k	Branch if Lower	if (C = 1) then PC ← PC + k + 1	None	1 / 2
BRMI	k	Branch if Minus	if (N = 1) then PC ← PC + k + 1	None	1 / 2
BRPL	k	Branch if Plus	if (N = 0) then PC ← PC + k + 1	None	1 / 2
BRGE	k	Branch if Greater or Equal, Signed	if (N ⊕ V= 0) then PC ← PC + k + 1	None	1 / 2
BRLT	k	Branch if Less Than Zero, Signed	if (N ⊕ V= 1) then PC ← PC + k + 1	None	1 / 2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC ← PC + k + 1	None	1 / 2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC ← PC + k + 1	None	1 / 2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC ← PC + k + 1	None	1 / 2
BRTC	k	Branch if T Flag Cleared	if (T = 0) then PC ← PC + k + 1	None	1 / 2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC ← PC + k + 1	None	1 / 2
BRVC	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC ← PC + k + 1	None	1 / 2

Mnemonics	Operands	Description	Operation	Flags	#Clocks
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then PC ← PC + k + 1	None	1 / 2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC ← PC + k + 1	None	1 / 2
DATA TRANSFER INSTRUCTIONS					
MOV	Rd, Rr	Move Between Registers	Rd ← Rr	None	1
MOVW	Rd, Rr	Copy Register Word	Rd+1:Rd ← Rr+1:Rr	None	1
LDI	Rd, K	Load Immediate	Rd ← K	None	1
LD	Rd, X	Load Indirect	Rd ← (X)	None	2
LD	Rd, X+	Load Indirect and Post-Inc.	Rd ← (X), X ← X + 1	None	2
LD	Rd, - X	Load Indirect and Pre-Dec.	X ← X - 1, Rd ← (X)	None	2
LD	Rd, Y	Load Indirect	Rd ← (Y)	None	2
LD	Rd, Y+	Load Indirect and Post-Inc.	Rd ← (Y), Y ← Y + 1	None	2
LD	Rd, - Y	Load Indirect and Pre-Dec.	Y ← Y - 1, Rd ← (Y)	None	2
LDD	Rd,Y+q	Load Indirect with Displacement	Rd ← (Y + q)	None	2
LD	Rd, Z	Load Indirect	Rd ← (Z)	None	2
LD	Rd, Z+	Load Indirect and Post-Inc.	Rd ← (Z), Z ← Z+1	None	2
LD	Rd, -Z	Load Indirect and Pre-Dec.	Z ← Z - 1, Rd ← (Z)	None	2
LDD	Rd, Z+q	Load Indirect with Displacement	Rd ← (Z + q)	None	2
LDS	Rd, k	Load Direct from SRAM	Rd ← (k)	None	2
ST	X, Rr	Store Indirect	(X) ← Rr	None	2
ST	X+, Rr	Store Indirect and Post-Inc.	(X) ← Rr, X ← X + 1	None	2
ST	- X, Rr	Store Indirect and Pre-Dec.	X ← X - 1, (X) ← Rr	None	2
ST	Y, Rr	Store Indirect	(Y) ← Rr	None	2
ST	Y+, Rr	Store Indirect and Post-Inc.	(Y) ← Rr, Y ← Y + 1	None	2
ST	- Y, Rr	Store Indirect and Pre-Dec.	Y ← Y - 1, (Y) ← Rr	None	2
STD	Y+q,Rr	Store Indirect with Displacement	(Y + q) ← Rr	None	2
ST	Z, Rr	Store Indirect	(Z) ← Rr	None	2
ST	Z+, Rr	Store Indirect and Post-Inc.	(Z) ← Rr, Z ← Z + 1	None	2
ST	-Z, Rr	Store Indirect and Pre-Dec.	Z ← Z - 1, (Z) ← Rr	None	2
STD	Z+q,Rr	Store Indirect with Displacement	(Z + q) ← Rr	None	2
STS	k, Rr	Store Direct to SRAM	(k) ← Rr	None	2
LPM		Load Program Memory	R0 ← (Z)	None	3
LPM	Rd, Z	Load Program Memory	Rd ← (Z)	None	3
LPM	Rd, Z+	Load Program Memory and Post-Inc	Rd ← (Z), Z ← Z+1	None	3
SPM		Store Program Memory	(Z) ← R1:R0	None	-
IN	Rd, P	In Port	Rd ← P	None	1
OUT	P, Rr	Out Port	P ← Rr	None	1
PUSH	Rr	Push Register on Stack	STACK ← Rr	None	2
POP	Rd	Pop Register from Stack	Rd ← STACK	None	2
BIT AND BIT-TEST INSTRUCTIONS					
SBI	P,b	Set Bit in I/O Register	I/O(P,b) ← 1	None	2
CBI	P,b	Clear Bit in I/O Register	I/O(P,b) ← 0	None	2
LSL	Rd	Logical Shift Left	Rd(n+1) ← Rd(n), Rd(0) ← 0	Z,C,N,V	1
LSR	Rd	Logical Shift Right	Rd(n) ← Rd(n+1), Rd(7) ← 0	Z,C,N,V	1
ROL	Rd	Rotate Left Through Carry	Rd(0)←C,Rd(n+1)← Rd(n),C←Rd(7)	Z,C,N,V	1
ROR	Rd	Rotate Right Through Carry	Rd(7)←C,Rd(n)← Rd(n+1),C←Rd(0)	Z,C,N,V	1
ASR	Rd	Arithmetic Shift Right	Rd(n) ← Rd(n+1), n=0..6	Z,C,N,V	1
SWAP	Rd	Swap Nibbles	Rd(3..0)←Rd(7..4),Rd(7..4)←Rd(3..0)	None	1
BSET	s	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	s	Flag Clear	SREG(s) ← 0	SREG(s)	1
BST	Rr, b	Bit Store from Register to T	T ← Rr(b)	T	1
BLD	Rd, b	Bit load from T to Register	Rd(b) ← T	None	1
SEC		Set Carry	C ← 1	C	1
CLC		Clear Carry	C ← 0	C	1
SEN		Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 0	N	1
SEZ		Set Zero Flag	Z ← 1	Z	1
CLZ		Clear Zero Flag	Z ← 0	Z	1
SEI		Global Interrupt Enable	I ← 1	I	1
CLI		Global Interrupt Disable	I ← 0	I	1
SES		Set Signed Test Flag	S ← 1	S	1
CLS		Clear Signed Test Flag	S ← 0	S	1
SEV		Set Twos Complement Overflow.	V ← 1	V	1
CLV		Clear Twos Complement Overflow	V ← 0	V	1
SET		Set T in SREG	T ← 1	T	1
CLT		Clear T in SREG	T ← 0	T	1
SEH		Set Half Carry Flag in SREG	H ← 1	H	1

Mnemonics	Operands	Description	Operation	Flags	#Clocks
CLH		Clear Half Carry Flag in SREG	H ← 0	H	1
MCU CONTROL INSTRUCTIONS					
NOP		No Operation		None	1
SLEEP		Sleep	(see specific descr. for Sleep function)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR/timer)	None	1
BREAK		Break	For On-Chip Debug Only	None	N/A

Ordering Information

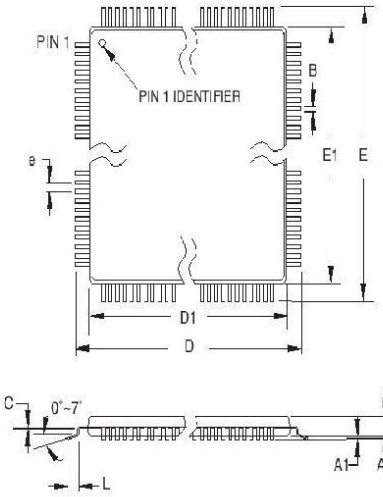
Speed (MHz)	Power Supply	Ordering Code	Package	Operation Range
8	2.7V - 5.5V	ATmega16L-8AU[1] ATmega16L-8PU[1] ATmega16L-8MU[1]	44A 40P6 44M1	Industrial (-40°C to 85°C)
16	4.5V - 5.5V	ATmega16-16AU[1] ATmega16-16PU[1] ATmega16-16MU[1]	44A 40P6 44M1	Industrial (-40°C to 85°C)

Note: 1. Pb-free packaging complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.

Package Type	
44A	44-lead, Thin (1.0 mm) Plastic Gull Wing Quad Flat Package (TQFP)
40P6	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 × 7 × 1.0 mm body, lead pitch 0.50 mm, Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)

Packaging Information

44A



COMMON DIMENSIONS
(Unit of Measure = mm)

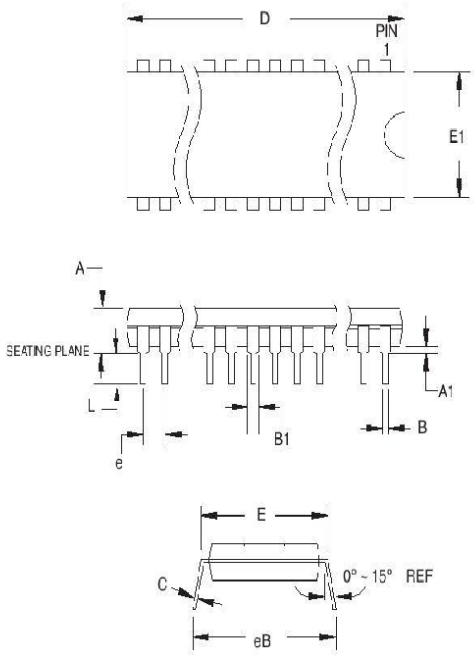
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	11.75	12.00	12.25	
D1	9.90	10.00	10.10	Note 2
E	11.75	12.00	12.25	
E1	9.90	10.00	10.10	Note 2
B	0.30	–	0.45	
C	0.09	–	0.20	
L	0.45	–	0.75	
e	0.80 TYP			

Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10 mm maximum.

10/5/2001

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**44A**, 44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness, 0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)	44A	B

40P6



COMMON DIMENSIONS
(Unit of Measure = mm)

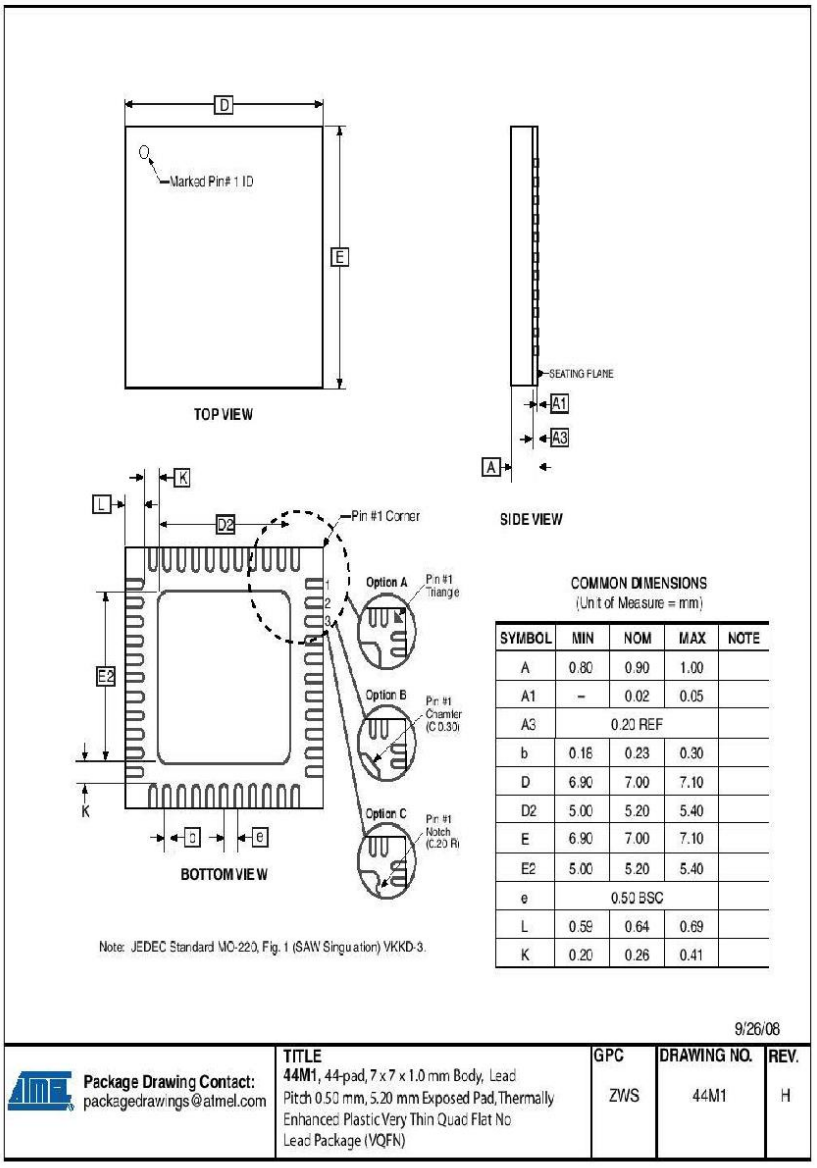
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	4.826	
A1	0.381	–	–	
D	52.070	–	52.578	Note 2
E	15.240	–	15.875	
E1	13.462	–	13.970	Note 2
B	0.356	–	0.559	
B1	1.041	–	1.651	
L	3.048	–	3.556	
C	0.203	–	0.381	
eB	15.494	–	17.526	
e	2.540 TYP			

Notes:
1. This package conforms to JEDEC reference MS-011, Variation AC.
2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

09/28/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**40P6**, 40-lead (0.600"/15.24 mm Wide) Plastic Dual Inline Package (PDIP)	40P6	B

44M1

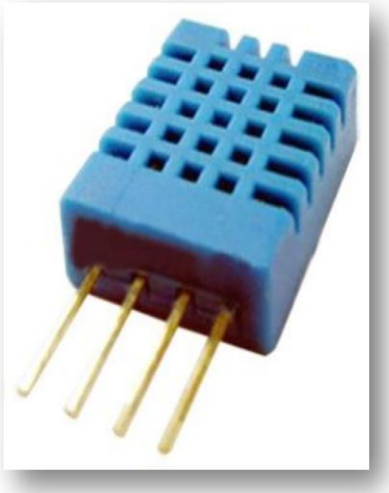


COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	–	0.02	0.05	
A3		0.20 REF		
b	0.16	0.23	0.30	
D	6.90	7.00	7.10	
D2	5.00	5.20	5.40	
E	6.90	7.00	7.10	
E2	5.00	5.20	5.40	
e		0.50 BSC		
L	0.59	0.64	0.69	
K	0.20	0.26	0.41	

9/26/08

Package Drawing Contact: packagedrawings@atmel.com	TITLE	GPC	DRAWING NO.	REV.
	44M1, 44-pad, 7 x 7 x 1.0 mm Body, Lead Pitch 0.50 mm, 5.20 mm Exposed Pad, Thermally Enhanced Plastic Very Thin Quad Flat No Lead Package (VQFN)	ZWS	44M1	H



Each DHT11 element is strictly calibrated in the laboratory that is extremely accurate on humidity calibration. The calibration coefficients are stored as programmes in the OTP memory, which are used by the sensor's internal signal detecting process. The single-wire serial interface makes system integration quick and easy. Its small size, low power consumption and up-to-20 meter signal transmission making it the best choice for various applications, including those most demanding ones. The component is 4-pin single row pin package. It is convenient to connect and special packages can be provided according to users' request.

2. Technical Specifications:

Overview:

Item	Measurement Range	Humidity Accuracy	Temperature Accuracy	Resolution	Package
DHT11	20-90%RH 0-50 ℃	±5%RH	±2℃	1	4 Pin Single Row

Detailed Specifications:

Parameters	Conditions	Minimum	Typical	Maximum
Humidity				
Resolution		1%RH	1%RH	1%RH
			8 Bit	
Repeatability			±1%RH	
Accuracy	25℃		±4%RH	
	0-50℃			±5%RH
Interchangeability	Fully Interchangeable			
Measurement Range	0℃	30%RH		90%RH
	25℃	20%RH		90%RH
	50℃	20%RH		80%RH
Response Time (Seconds)	1/e(63%)25℃, 1m/s Air	6 S	10 S	15 S
Hysteresis			±1%RH	
Long-Term Stability	Typical		±1%RH/year	
Temperature				
Resolution		1℃	1℃	1℃
		8 Bit	8 Bit	8 Bit
Repeatability			±1℃	
Accuracy		±1℃		±2℃
Measurement Range		0℃		50℃
Response Time (Seconds)	1/e(63%)	6 S		30 S

3. Typical Application (Figure 1)

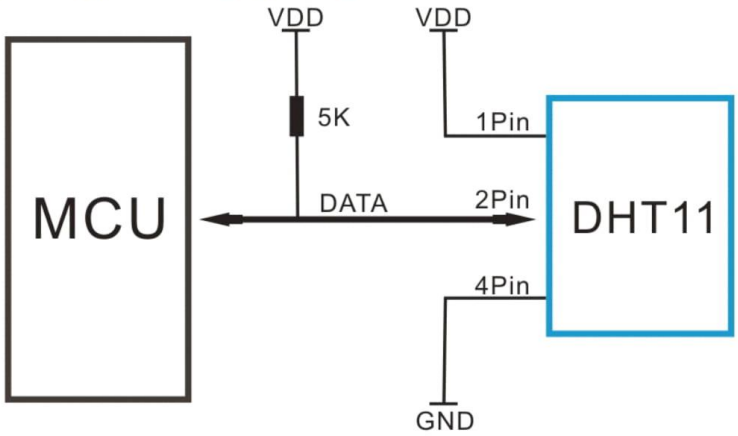


Figure 1 Typical Application

Note: 3Pin – Null; MCU = Micro-computer Unite or single chip Computer

When the connecting cable is shorter than 20 metres, a 5K pull-up resistor is recommended; when the connecting cable is longer than 20 metres, choose a appropriate pull-up resistor as needed.

4. Power and Pin

DHT11's power supply is 3-5.5V DC. When power is supplied to the sensor, do not send any instruction to the sensor in within one second in order to pass the unstable status. One capacitor valued 100nF can be added between VDD and GND for power filtering.

5. Communication Process: Serial Interface (Single-Wire Two-Way)

Single-bus data format is used for communication and synchronization between MCU and DHT11 sensor. One communication process is about 4ms.

Data consists of decimal and integral parts. A complete data transmission is **40bit**, and the sensor sends **higher data bit** first.
Data format: 8bit integral RH data + 8bit decimal RH data + 8bit integral T data + 8bit decimal T data + 8bit check sum. If the data transmission is right, the check-sum should be the last 8bit of "8bit integral RH data + 8bit decimal RH data + 8bit integral T data + 8bit decimal T data".

5.1 Overall Communication Process (Figure 2, below)

When MCU sends a start signal, DHT11 changes from the low-power-consumption mode to the running-mode, waiting for MCU completing the start signal. Once it is completed, DHT11 sends a response signal of 40-bit data that include the relative humidity and temperature information to MCU. Users can choose to collect (read) some data. Without the start signal from MCU, DHT11 will not give the response signal to MCU. Once data is collected, DHT11 will change to the low-power-consumption mode until it receives a start signal from MCU again.

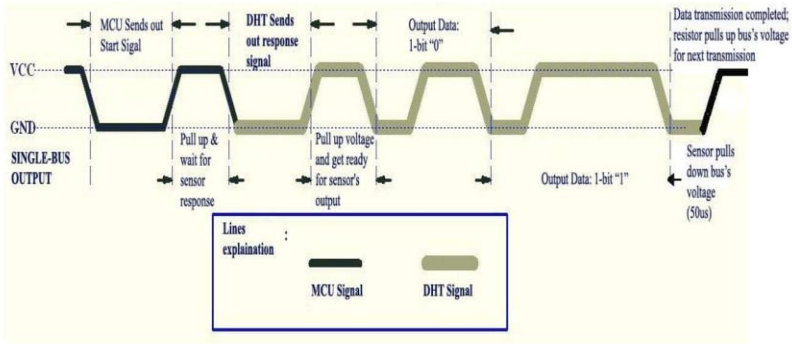


Figure 2 Overall Communication Process

5.2 MCU Sends out Start Signal to DHT (Figure 3, below)

Data Single-bus free status is at high voltage level. When the communication between MCU and DHT11 begins, the programme of MCU will set Data Single-bus voltage level from high to low and this process must take at least 18ms to ensure DHT's detection of MCU's signal, then MCU will pull up voltage and wait 20-40us for DHT's response.

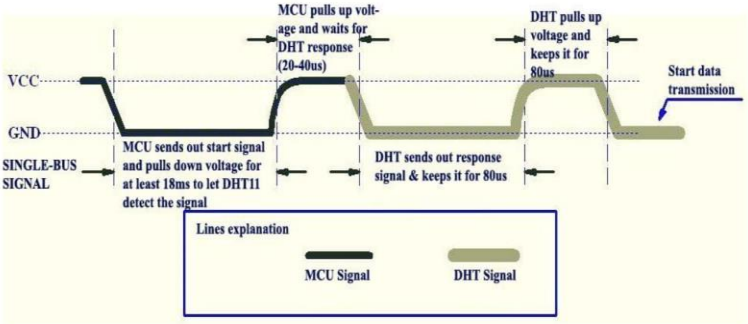


Figure 3 MCU Sends out Start Signal & DHT Responses

5.3 DHT Responses to MCU (Figure 3, above)

Once DHT detects the start signal, it will send out a low-voltage-level response signal, which lasts 80us. Then the programme of DHT sets Data Single-bus voltage level from low to high and keeps it for 80us for DHT's preparation for sending data.

When DATA Single-Bus is at the low voltage level, this means that DHT is sending the response signal. Once DHT sent out the response signal, it pulls up voltage and keeps it for 80us and prepares for data transmission.

When DHT is sending data to MCU, every bit of data begins with the 50us low-voltage-level and the length of the following high-voltage-level signal determines whether data bit is "0" or "1" (see Figures 4 and 5 below).

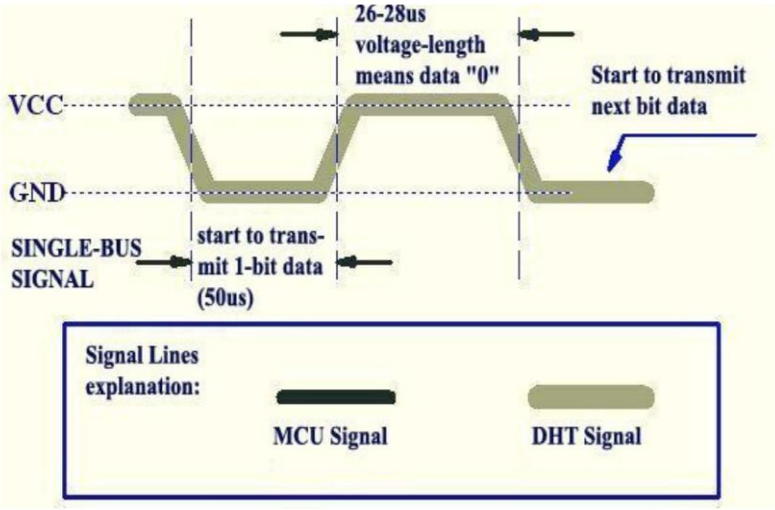


Figure 4 Data "0" Indication

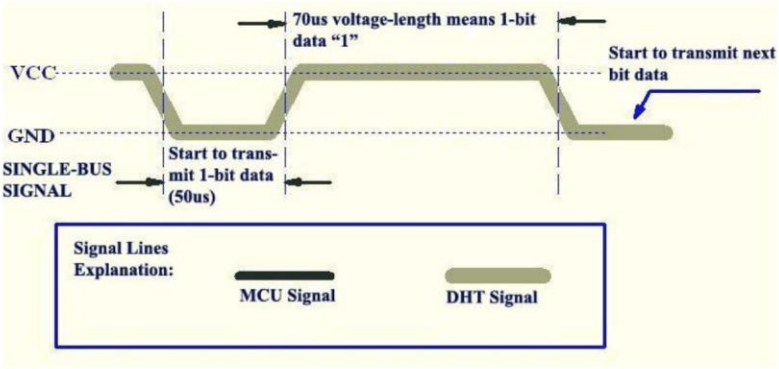


Figure 5 Data "1" Indication

If the response signal from DHT is always at high-voltage-level, it suggests that DHT is not responding properly and please check the connection. When the last bit data is transmitted, DHT11 pulls down the voltage level and keeps it for 50us. Then the Single-Bus voltage will be pulled up by the resistor to set it back to the free status.

6. Electrical Characteristics

VDD=5V, T = 25℃ (unless otherwise stated)

	Conditions	Minimum	Typical	Maximum
Power Supply	DC	3V	5V	5.5V
Current Supply	Measuring	0.5mA		2.5mA
	Average	0.2mA		1mA
	Standby	100uA		150uA
Sampling period	Second	1		

Note: Sampling period at intervals should be no less than 1 second.

7. Attentions of application

(1) Operating conditions

Applying the DHT11 sensor beyond its working range stated in this datasheet can result in 3%RH signal shift/discrepancy. The DHT11 sensor can recover to the calibrated status gradually when it gets back to the normal operating condition and works within its range. Please refer to (3) of

this section to accelerate its recovery. Please be aware that operating the DHT11 sensor in the non-normal working conditions will accelerate sensor's aging process.

(2) Attention to chemical materials

Vapor from chemical materials may interfere with DHT's sensitive-elements and debase its sensitivity. A high degree of chemical contamination can permanently damage the sensor.

(3) Restoration process when (1) & (2) happen

Step one: Keep the DHT sensor at the condition of Temperature 50~60Celsius, humidity <10%RH for 2 hours;
Step two:K keep the DHT sensor at the condition of Temperature 20~30Celsius, humidity >70%RH for 5 hours.

(4) Temperature Affect

Relative humidity largely depends on temperature. Although temperature compensation technology is used to ensure accurate measurement of RH, it is still strongly advised to keep the humidity and temperature sensors working under the same temperature. DHT11 should be mounted at the place as far as possible from parts that may generate heat.

(5) Ligh t Affect

Long time exposure to strong sunlight and ultraviolet may debase DHT's performance.

(6) Connection wires

The quality of connection wires will affect the quality and distance of communication and high quality shielding-wire is recommended.

(7) Other attentions

* Welding temperature should be bellow 260Celsius and contact should take less than 10 seconds.
* Avoid using the sensor under dew condition.
* Do not use this product in safety or emergency stop devices or any other occasion that failure of DHT11 may cause personal injury.
* Storage: Keep the sensor at temperature 10-40℃, humidity <60%RH.

Disclaimer

This is a translated version of the manufacturer's data sheet. OSEPP is not responsible for the accuracy of the translated information.

VISHAY

LCD-016M002B

Vishay

16 x 2 Character LCD

FEATURES

- 5 x 8 dots with cursor
- Built-in controller (KS 0066 or Equivalent)
- + 5V power supply (Also available for + 3V)
- 1/16 duty cycle
- B/L to be driven by pin 1, pin 2 or pin 15, pin 16 or A.K (LED)
- N.V. optional for + 3V power supply

MECHANICAL DATA

ITEM	STANDARD VALUE	UNIT
Module Dimension	80.0 x 36.0	mm
Viewing Area	66.0 x 16.0	mm
Dot Size	0.56 x 0.66	mm
Character Size	2.96 x 5.56	mm

ABSOLUTE MAXIMUM RATING

ITEM	SYMBOL	STANDARD VALUE			UNIT
		MIN.	TYP.	MAX.	
Power Supply	VDD-VSS	- 0.3	–	7.0	V
Input Voltage	VI	- 0.3	–	VDD	V

NOTE: VSS = 0 Volt, VDD = 5.0 Volt

ELECTRICAL SPECIFICATIONS

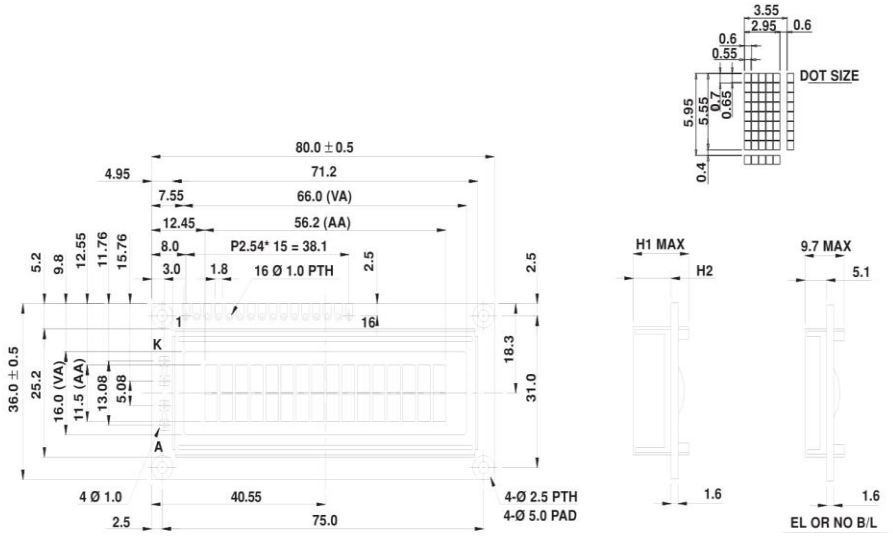
ITEM	SYMBOL	CONDITION		STANDARD VALUE			UNIT
				MIN.	TYP.	MAX.	
Input Voltage	VDD	VDD = + 5V		4.7	5.0	5.3	V
		VDD = + 3V		2.7	3.0	5.3	V
Supply Current	IDD	VDD = 5V		–	1.2	3.0	mA
Recommended LC Driving Voltage for Normal Temp. Version Module	VDD - V0	- 20 °C		–	–	–	V
		0°C		4.2	4.8	5.1	
		25°C		3.8	4.2	4.6	
		50°C		3.6	4.0	4.4	
		70°C		–	–	–	
LED Forward Voltage	VF	25°C		–	4.2	4.6	V
LED Forward Current	IF	25°C	Array	–	130	260	mA
			Edge	–	20	40	
EL Power Supply Current	IEL	Vel = 110VAC:400Hz		–	–	5.0	mA

DISPLAY CHARACTER ADDRESS CODE:

Display Position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DD RAM Address	00	01														0F
DD RAM Address	40	41														4F

PIN NUMBER	SYMBOL	FUNCTION
1	Vss	GND
2	Vdd	+ 3V or + 5V
3	Vo	Contrast Adjustment
4	RS	H/L Register Select Signal
5	R/$\overline{W}$	H/L Read/Write Signal
6	E	H →L Enable Signal
7	DB0	H/L Data Bus Line
8	DB1	H/L Data Bus Line
9	DB2	H/L Data Bus Line
10	DB3	H/L Data Bus Line
11	DB4	H/L Data Bus Line
12	DB5	H/L Data Bus Line
13	DB6	H/L Data Bus Line
14	DB7	H/L Data Bus Line
15	A/Vee	+ 4.2V for LED/Negative Voltage Output
16	K	Power Supply for B/L (OV)

DIMENSIONS in millimeters



LED - H/L B/L		
	HIGH	LOW
H1	13.2	12.1
H2	8.6	7.5

Lampiran B1

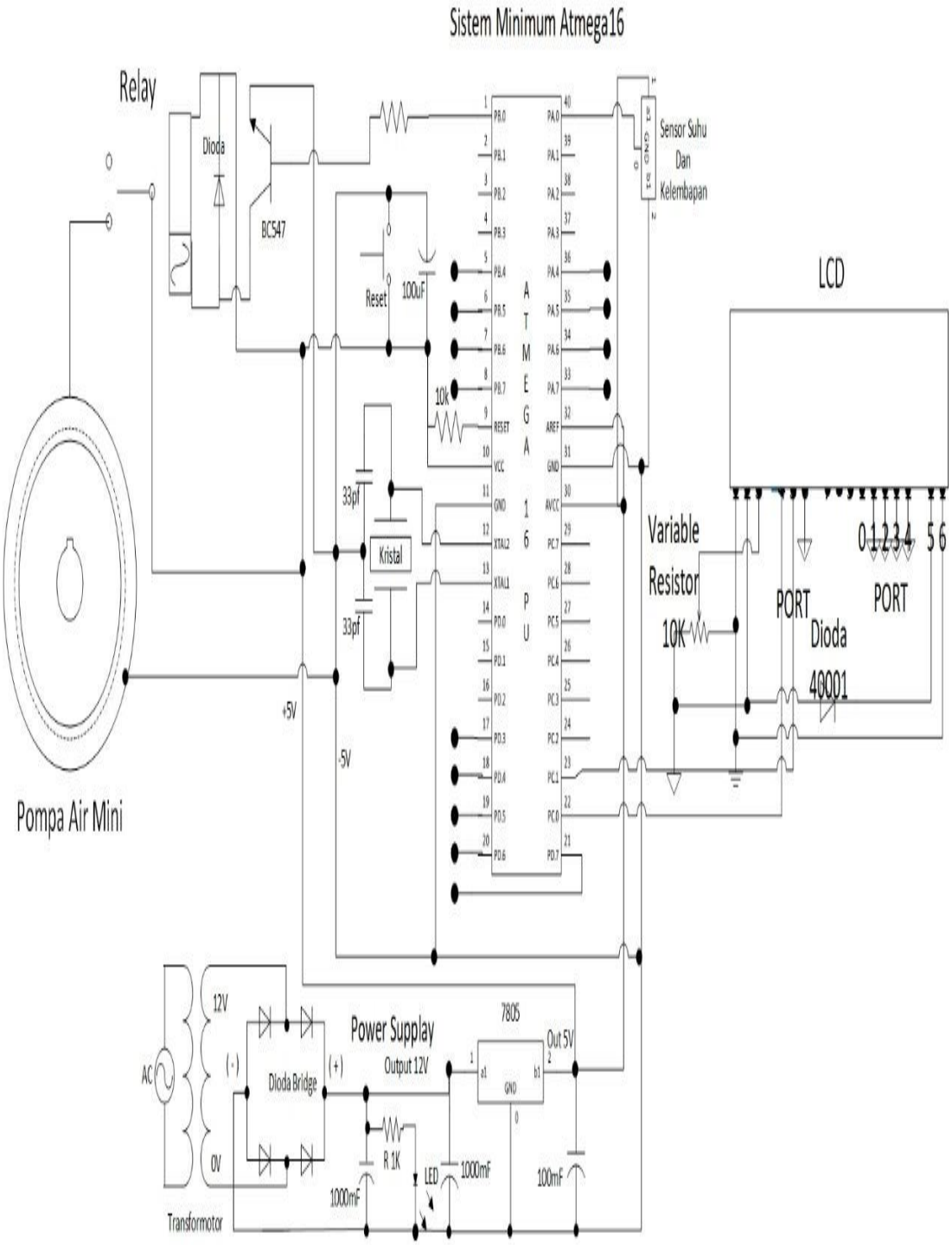
```
#include <mega16.h>
#include <stdlib.h>
#include <delay.h>
#include <stdio.h>

// Alphanumeric LCD Module functions
#include <alcd.h>

#define ADC_VREF_TYPE 0x00

// Read the AD conversion result
unsigned int read_adc(unsigned char adc_input)
{
ADMUX=adc_input | (ADC_VREF_TYPE & 0xff);
// Delay needed for the stabilization of the ADC input voltage
delay_us(10);
// Start the AD conversion
ADCSRA|=0x40;
// Wait for the AD conversion to complete
while ((ADCSRA & 0x10)==0);
ADCSRA|=0x10;
return ADCW;
}

// Declare your global variables here
unsigned int udara;
float suhu,lembab;
```

```
unsigned char tampil[16];


void baca_udara(void)
{
lcd_clear();
udara= read_adc(0);
suhu=(float)udara*500/1024;
lembab=(float)udara*500/450;//(udara*0.0405)-(udara*udara*0.0000028)-
4);


lcd_gotoxy(0,0) ;
lcd_putsf("S U H U = ");


ftoa(suhu,0,tampil);//float to array, mengubah tipedata float ke tipe data array
yg akan ditampilkan di LCD
lcd_gotoxy(10,0) ;
lcd_puts(tampil);


lcd_gotoxy(14,0) ;
lcd_putchar(0xdf);//menampilkan karakter derajat
lcd_putsf("C");
delay_ms(100);


lcd_gotoxy(0,1) ;
lcd_putsf("LEMBAB = ");


ftoa(lembab,0,tampil);//float to array, mengubah tipedata float ke tipe data
array yg akan ditampilkan di LCD
lcd_gotoxy(8,1) ;
lcd_puts(tampil);
```

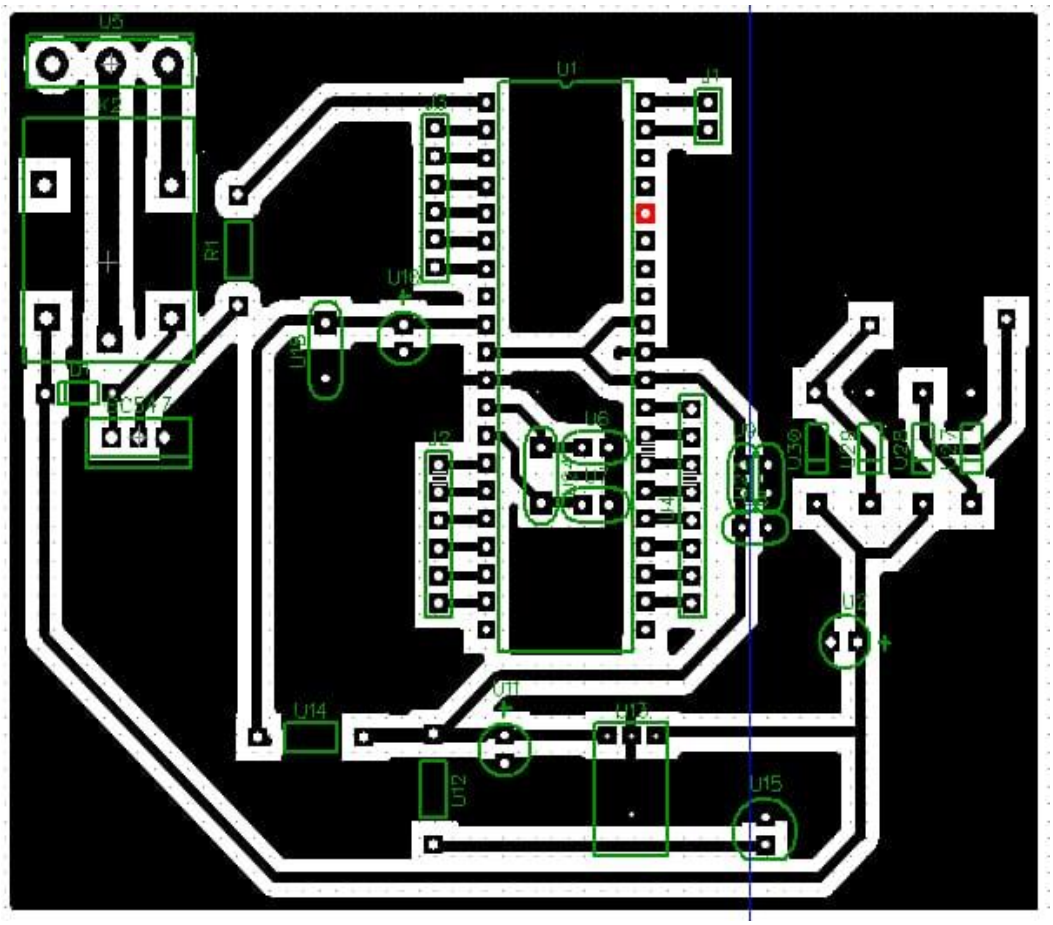
```
lcd_gotoxy(13,1) ;
lcd_putsf("%");
delay_ms(100);
}

void hidup(void)
{
PORTB.0=1;
}
void mati(void)
{
PORTB.0=0;
}
void main(void)
{
PORTA=0x00;
DDRA=0x00;
PORTB=0xFF;
DDRB=0xFF;
PORTC=0x00;
DDRC=0x00;

ACSR=0x80;
SFIOR=0x00;

ADMUX=ADC_VREF_TYPE & 0xff;
ADCSRA=0x87;
lcd_init(16);

while (1)
```

```
    {
    baca_udara();

    if(lembab>50 || lembab<70)
    {
    mati();
    }
    else if(lembab<50 || lembab>70)
    {
    hidup();
    }

    }
}
```

Lampiran C1


Sistem Minimum Atmega16
Relay
Dioda
BC547
Reset
100uF
10k
33pf
Kristal
33pf
+5V
-5V
Pompa Air Mini
ATMEGA16PU
Sensor Suhu Dan Kelembapan
LCD
Variable Resistor 10K
PORT
Dioda 4001
PORT
0 1 2 3 4 5 6
Power Supplay
Output 12V
7805
Out 5V
GND
AC
12V
0V
(-)
(+)
Dioda Bridge
R 1K
LED
1000mF
1000mF
100mF
Transformotor

Lampiran D1



Lampiran E1

No.	Komponen	Jumlah	Harga Satuan	Harga
1.	ATMega 16 + Socet IC	1	100.000	100.000
2.	Trafo 1A Ø	1	35.000	35.000
3.	Sensor DHT11	1	25.000	25.000
4.	Relay 5 V	1	30.000	30.000
5.	IC 7805	1	3.000	3.000
6.	Kristal 12MHz	1	3.000	3.000
7.	Kapasitor Elco 1000 µF	2	2.000	4.000
8.	Kapasitor Elco 100 µF	2	2.000	4.000
9.	LED	1	500	500
10.	LCD 2x16	1	50.000	50.000
11.	Transistor BC547	1	10.000	10.000
12.	Kapasitor Keramik 33 pF	2	500	1.000
13.	Push Button	1	2.000	2.000
14.	Dioda	5	3.000	15.000
15.	Resistor 10 KΩ	1	500	500
16.	Resistor 1 KΩ	1	500	500
17.	Resistor Variabel 10k (Trimpot)	1	2000	2000
18.	Resistor 330 Ω	1	500	500
19.	Socket Konektor	1	5.000	5.000
20.	Kabel Pelangi	1	7.500	7.500
21.	Kabel Power	1	5.000	5.000
22.	PCB	1	10.000	10.000
23.	Fericlorit (FeCl3)	1	5.000	5.000
24.	Speser (baut)	4	1.000	4.000
25.	Tempat Makan	1	25.000	25.000
26.	Baskom Kotak	1	30.000	30.000
27.	Pompa air aquarium	1	97.500	97.500
			Total	**475.000**

Lampiran F1